ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	terial Composition opyright 2005. IPC, Banational and Pan-American	on Declaration annockburn, Illin rican copyright o	on ois. All rights reserved conventions.	l under both	This docume level parts, th	ent is a declara he declaration	ation of the strength of the s	he substances asses all low	within the m er level mater	anufacture ials for whi	r listed iter ich the ma	m. Note: if nufacturer	f the item is an as has engineering	ssembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute					Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information				
Supplier Information															
Company name*			Company unique ID			Unique ID Authority					Response Date*				
onsemi											2025-06-07				
Contact Name			Title - Contact			Phone - Contact*					Email - Contact*				
Product-Env-Stewards			Product Enviro Compliance			NA					Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative			Phone - Representative*					Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance			NA					Product-Env-Stewards@onsemi.com				
Requester Item N	Requester Item Number Mfr Item N   NCV7471		m Number Mfr Item Name			Effective Da	ive Date Version Manufacturing Site		g Site	W	eight*	UOM	Unit Type		
			DQ5R2G CAN 2LIN 500mA BuBo SBC			2025-06-07 PHG			515.45		mg	Each			
Anufacturing Proce	ess Information		I			1					I		1		
Terminal Plating / Grid Array Material		Terminal	erminal Base Alloy J-STD-020		SL Rating	Peak Proces		ss Body Temperature Max Time at Peak		e at Peak T	Temperature Number		er of Reflow Cyc	cles	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		(no CU Alloy	CU Alloy 2			260		С	30		seconds 3				
omments															
TTENTION: MSL 2 Rate	ed item requires Dry	Pack (after elec	trical test)												
or more information rega	rding material compo	osition please re	fer to page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	15.99	mg	Supplier	Silicon (Si)	7440-21-3		15.99	mg
Die Attach	2.86	mg		Epoxy resin	proprietary data		0.286	mg
			Supplier	Silver (Ag)	7440-22-4		2.288	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.286	mg
Lead Frame	172.4	mg	Supplier	Zinc (Zn)	7440-66-6		0.1724	mg
			Supplier	Iron (Fe)	7439-89-6		3.9652	mg
			Supplier	Copper (Cu)	7440-50-8		168.09	mg
			Supplier	Phosphorus (P)	7723-14-0		0.1724	mg
Mold Compound-Black	322.04	mg		Epoxy resin	proprietary data		16.102	mg
			Supplier	Phenolic Resin	Proprietary Data		6.4408	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		8.051	mg
			Supplier	Carbon Black (C)	1333-86-4		1.6102	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		289.836	mg
Plating	1.62	mg	Supplier	Palladium (Pd)	7440-05-3		0.08	mg
			В	Nickel (Ni)	7440-02-0		1.4599	mg
			Supplier	Gold (Au)	7440-57-5		0.08	mg
Wire Bond - Au	0.54	mg	Supplier	Gold (Au)	7440-57-5		0.54	mg